

TencentOS-Tiny software package based on MDK development

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https://github.com/OpenAtomFoundation/TencentOS-tiny

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1. Introduction to ARM packs

1.1 Introduction to the software pack

ARM packs provide support for microcontroller devices and development boards, including Software Components such as drivers and middleware, and can include example projects and code templates. The following types of packs are available.

- (1) Device Family Pack (DFP): generated by a silicon supplier or tool vendor to provide support for creating software applications for a specific target microcontroller.
- (2) Board Support Pack: Published by the board supplier to provide software support for the peripheral hardware installed on the board.
- (3) CMSIS software pack: provided by ARM, including support for the CMSIS core, DSP and RTOS.
- (4) Middleware Pack: created by chip suppliers, tool suppliers or third parties; reduces development time by providing software integration of common software components (e.g. software stacks, special hardware libraries, etc.).
- (5) In-house components: developed by the tool user for internal or external distribution. The software components include the following.
 - (1) Source code, libraries, headers/configuration files and documentation.
- (2) Complete example project demonstrating the use of software components that can be downloaded and implemented on the evaluation hardware.
 - (3) Code templates to facilitate the use of software components.

A complete pack is a ZIP file containing all the required software libraries and files, as well as a pack description file (PDSC file) containing all the information about the pack, the structure of which is defined in CMSIS (http://www.keil.com/CMSIS/Pack).

1.2 Software pack development

1.2.1 The software pack development process

The process of developing a software pack is equivalent to the completion of a product, hence the introduction of the concept of Product Lifecycle Management (PLM), which consists of the following four phases: (1) concept generation, where the product is defined based on the pack requirements and the first functional prototype is created; (2) design, where the prototype is tested and the product is implemented according to the technical features and requirements, and the product is verified through extensive testing of functionality and specifications; (3) release, where the product is manufactured and brought to market; and (4) service, where the product is maintained, including support for customers, and finally continuous optimisation to end the product cycle.

The following are the main processes faced when creating a software pack.

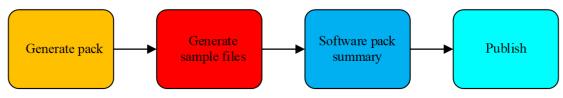


Figure 1.1 Software pack development process

First, the pack is generated according to the specific components, i.e. the software components such as header files and library files are organised according to the requirements using PDSC files, after which the corresponding version of the pack can be generated using the pack generation tool. The final pack will be generated after testing.

1.2.2 Preparation of PDSC documents

PDSC files are based on Extensible Markup Language (XML), which allows the modules contained in a pack to be organised in a specific format, and are described in detail according to the structure of a PDSC file.

The first two sentences are declared in XML format, which is defined in the PACK.xsd file in the MDK, so there is no need to modify it; the <name> and <vendor> tags define the basic contents of the pack and are also used for the file name of the PACK file, so this PDSC file should be named Tencent. TencentOS-tiny.pdsc; the < description > tag describes the pack information that will be displayed in the pack installer; the < url> tag can contain a URL with a link to download the pack for the user's convenience; the < license > tag contains the protocol that the user needs to follow to use the pack; the < support > tag contains a description of the pack. Figure 1.2 shows the pack interface for the following code.

```
<? xml version="1.0" encoding="utf-8"? >
<pack schemaVersion="1.0" xmlns:xs=http://www.w3.org/2001/XMLSchema-instancexs:noNamespaceSchemaLocation="PACK.xsd">
<name> Tencent</name>
<description > Description of your pack</description
<vendor> TencentOS-tiny</vendor>
<url> https://github.com/OpenAtomFoundation/TencentOS-tiny</url
<li>clicense>LICENSE.txt</license>
```

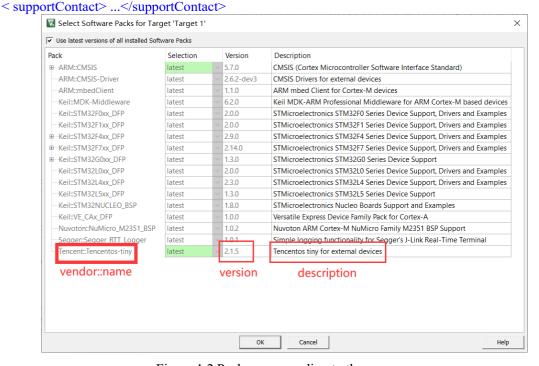


Figure 1.2 Pack corresponding to the program

Next are the modules of the PDSC file. The < releases> tag defines the version of the pack, where the developer can mark when the version is updated, so that when the pack is generated, the system will automatically generate the latest version of the pack.

```
<releases>
    <release version="1.0.1">
        Sep/3/2021, version name
    </release>
    <release version="1.0.0">
        Sep/1/2021, version name
    </release>
</release>
```

The < taxonomy> tag is used to define the description for each component, as shown in Figure 1.3, by identifying where the description is located with the following code for Cclass, Cgroup and Csub, doc is used to specify the description file (which may or may not be added) and then adding the name of the description.

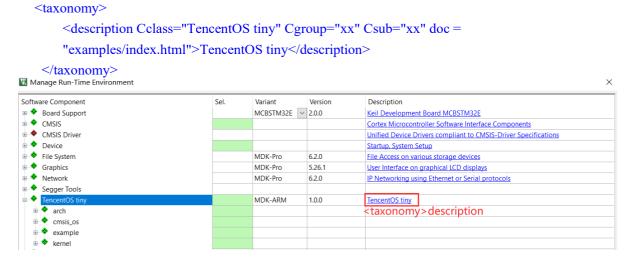


Figure 1.3 < taxonomy> tag

The < keywords > tag defines the keywords for the pack, which can be used to search for the pack you need when downloading packs from the ARM website.

The < requirements > tag defines the associated installation requirements for the pack, i.e. when installing this pack, other packs need to be installed online (URL: MDK5 Software Packs (keil.com)), for example the following definition requires us to install the CMSIS 5.7.0 pack for ARM.

Next is the < conditions> tag, which is used when designing < components> to indicate the dependencies of each component in the pack, i.e. the use of this component also requires the selection of other components. Under this tag multiple conditions can be defined, each of which can have multiple conditions defined, where < conditions id> is the condition name, < description> is the condition information, and then the defined condition, where < accept> means that the condition is optional. When multiple < accept>s exist, the user must satisfy at least one of them to use the condition; < require> means that the condition is mandatory, otherwise the component cannot be used. Within the conditions, there is some specific indicative syntax. If a condition named Cortex_M0 is selected by the developer when designing the < component>, then the user will need to comply with the condition when using the < component>: where <accept Dvendor="ARM:82" Dname="ARMCM0"/> means that the user needs to select the ARM-Cortex M0 core, <require condition="condition id"/> is a nested condition, which means that the user also needs to meet the requirements corresponding to that condition, <require Cclass="TencentOS tiny" Cgroup="kernel" Csub="core"/> indicates that the user also needs to select the core component.

Then there is the < components> tag, which describes all the files contained in the pack. When writing programs under this tag, the files need to be divided according to file categories. In the following code, a <component> of Keil:: TencentOS tiny:: arch::arch is defined and < description> is the information about the component, as shown in Figure 1.4.

ftware Component	Sel.	Variant	Version	Description
◆ CMSIS				Cortex Microcontroller Software Interface Components
MSIS Driver				Unified Device Drivers compliant to CMSIS-Driver Specifications
 Device 				Startup, System Setup <taxonomy>description</taxonomy>
File System		MDK-Pro	6.2.0	File Access on various storage devices
◆ Graphics		MDK-Pro	5.26.1	User Interface on graphical LCD displays
 Network Segger Tools 		MDK-Pro Cvariant	6.2.0	IP Networking using Ethernet or Serial protocols
Tencentos tiny Cclass				
arch Cgroup			Cversion	<component>description</component>
arch Csub	▼		1.0.1	arch for arm_v7m_cortex_m4_armcc
⊕ ❖ cmsis_os				
example				
⊕ ♦ kernel				
◆ USB		MDK-Pro	6.2.0	USB Communication with various device classes
• mbed				

Figure 1.4 < component > definition screen

condition="condition id" is the <condition> tag introduced above, so that the user also needs to satisfy the dependencies required by the condition when using the component. In addition, when defining a <component>, files need to be added according to the <files> ...</files> syntax of the above procedure, where the file category is defined as shown in Table 1-1, where the path to the file and the specific In the pack, the files we add are not editable by default. To make it easier for the user to configure the files, we need to add the attribute attr="config" and update the different versions of the files by version.

category

doc

Documents, which can be web pages or other links

include

Contains all the headers under a certain path

header

Contains specific header files under a certain path

source

.c source file

Table 1-1 File category definitions

In order to adapt the pack we design to different cores, i.e. none of the files that do not match the user's ARM core when using the pack, we can add <files> as follows: (1) in the condition condition, add a program like < require Dvendor="ARM:82" Dname=" ARMCM0"/>, which indicates that the user is required to select the ARM Cortex-M0 core; (2) when adding the <files>, we can keep the same name for the Cgroup and Csub of the same type of file for different cores, and add the condition defined in (1), so that when the user selects the for different kernels, only the files consistent with that kernel will appear.

Also, if multiple packs need to be defined in a PDSC file, the following code structure can be used, where each < bundle> tag defines a pack.

</bundle>

In addition, PDSC files can also contain <devices>, <apis>, <boards> and <examples>, which are provided by ARM or other device or board manufacturers, for the device, api library files, board level and corresponding example files, as described in ARM CMSIS packs.

Finally, the PDSC file needs to be completed by adding </pack> at the end to indicate the end of the file.

1.2.3 Generating packs

After the PDSC file has been written, in order to generate the final pack, three more files need to be prepared as shown in Figure 1.5. PackChk.exe is used to verify that all the files included in the pack exist, i.e. are complete; gen_pack.bat is a Windows batch file that requires us to make changes to the path in the file and is used to generate the pack PACK. xsd is the schema, which is used to develop the XML specification to validate the PDSC files we have written. In addition, the 7-Zip File Manager software is needed to compress the files and create the integrated packs.

PackChk.exe	2021/7/19 22:39	应用程序	2,485 KB
gen_pack.bat PACK.xsd	2021/9/2 14:16 2021/7/19 22:39	Windows 批处理文件 XML Schema File	3 KB 85 KB
	G z		
	7-Zip File Manager		

Figure 1.5 Software configuration required to generate the pack

First open gen_pack.bat using Notepad or Notepad++ and make the following changes to the following areas, as shown in Table 1-2.

```
SET ZIPPATH=C:\Program Files\7-Zip

SET RELEASE_PATH=..\Local_Release

SET PACK_VENDOR=Tencent

SET PACK_NAME=TencentOS-tiny

SET PACK_FOLDER_LIST=arch osal kernel examples

SET PACK_FILE_LIST=%PACK_VENDOR%.%PACK_NAME%.pdsc README.md LICENSE.txt
```

Table 1-2 gen pack.bat modifications

Code	Meaning
SET ZIPPATH	Installation path for 7-Zip File Manager software
SET RELEASE_PATH	The path to the generated pack, as a relative path
SET PACK_VENDOR	The <vendor> tag in the PDSC file</vendor>
SET PACK_NAME	The <name> tag in the PDSC file</name>
SET PACK_FOLDER_LIST	Path to where the pack contains the files
SET PACK_FILE_LIST	Path to README.md LICENSE.txt

Once you have modified gen_pack.bat, you can create the pack by first using cmd to open the command line interface of your computer, executing the cd command to go to the path where gen pack.bat is located, then typing gen pack.bat and clicking enter, as shown in Figure 1.6.

gen_pack.bat will compress the files in order, then read the The PDSC file will then be read, checkedfor data integrity and file dependencies, and the pack will be generated.

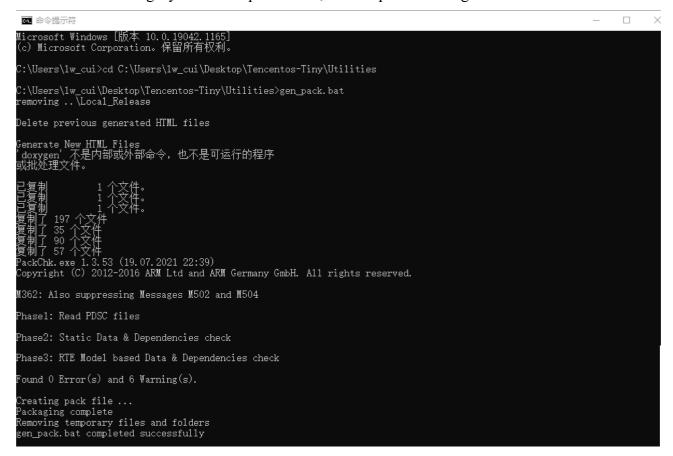


Figure 1.6 Pack generation interface

At this point the generated packs can be seen under the Local Release path.



Figure 1.7 Software pack

2. TencentOS-tiny pack

Tencent IoT operating system (TencentOS tiny) is a real-time operating system developed by Tencent for the IoT field, featuring low power consumption, low resource consumption, modularity and scalability. tiny provides the most streamlined RTOS kernel, which is scalable and configurable, and can be flexibly ported to a variety of terminal MCUs. At the same time, TencentOS tiny provides one-stop software solutions for IoT terminal manufacturers to facilitate the rapid access of various IoT devices to Tencent Cloud. It can support a variety of industry applications such as smart city, smart water meter, smart home, smart wear, and connected car.

Therefore, in order to effectively reduce developers' development time in porting TencentOS tiny to ARM kernel microcontrollers, this paper completes the packaging of third-party TencentOS Tiny pack and packs based on MDK, enabling the use of MDK pack to directly generate TencentOS Tiny projects for different MCUs.

2.1 Software pack contents

In conjunction with the algorithmic architecture of TencentOS tiny, the pack designed in this paper includes the elements shown in Table 2-1.

Table 2-1 Software pack contents Contents **Function** Includes arch files for cores Cortex-M0+, Cortex-M0, Cortex-M3, Cortex-M4, Cortex-M7, Cortex-M23, arch Cortex-M33 under TencentOS-tiny\arch\arm Including the files in the core, hal path under kernel TencentOS-tiny\kernel and tos config file cmsis os Files corresponding to TencentOS-tiny\osal\cmsis os helloworld main The main file for testing the pack The interrupt functions need to be modified according mcu it.c example to this file when porting the pack The user can add the header file of the corresponding mcu platform.h microcontroller to this file

The software pack has the following features.

- (1) The pack packs the TencentOS tiny software for the ARMCortex-M0+, Cortex-M0, Cortex-M3, Cortex-M4, Cortex-M7, Cortex-M23 and Cortex-M33 cores, allowing users to quickly integrate the TencentOS tiny corresponding kernel in a Keil project.
- (2) The pack can automatically adapt to the kernel selected by the user and the arch file can be displayed automatically according to the kernel, thus facilitating the user's use.
- (3) When the user checks a component, the pack will automatically prompt that other modules need to be checked and can be checked with one click using Resolve in the interface to prevent omissions.
- (4) Users can modify the tos config file of the corresponding kernel on their own to tailor the functions of TencentOS tiny.

2.2 Software pack installation

The next step is to introduce the installation of Tencent.TencentOS-tiny pack, first double-click the pack in Figure 1.5, then enter the installation interface as shown in Figure 2.1(a), click I agree to all the terms of the preceding License Agreement, then click next to install. The installation completion screen is shown in Figure 2.1(b).

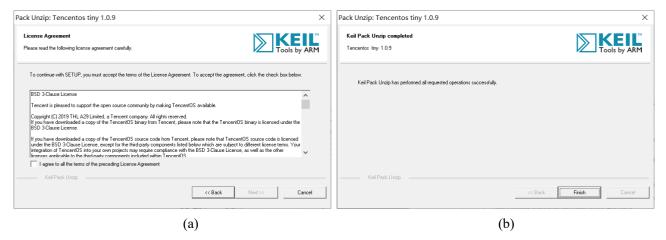


Figure 2.1 Installation screen

At this point the pack has been installed into Keil 5, open the Keil 5 software and click on the Pack Installer icon to install and remove the different pack versions.

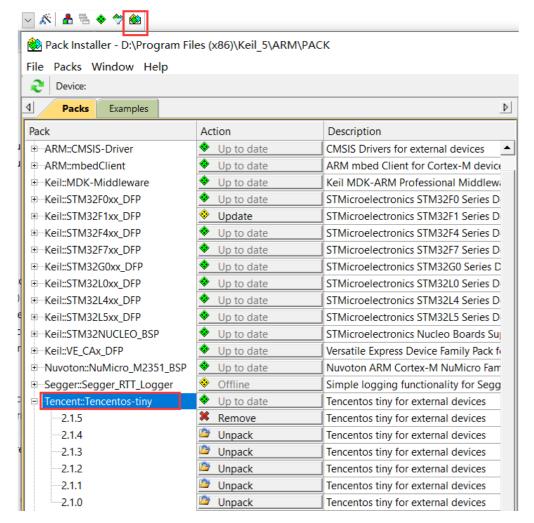


Figure 2.2 Pack Installer interface

Next you can install the components in the Tencent. TencentOS-tiny pack. Click on the Manage Run-Time Environment icon and tick the files that need to be ported from the pack, as shown in Figure 2.3. If there are dependencies you can click Resolve to install them with one click.

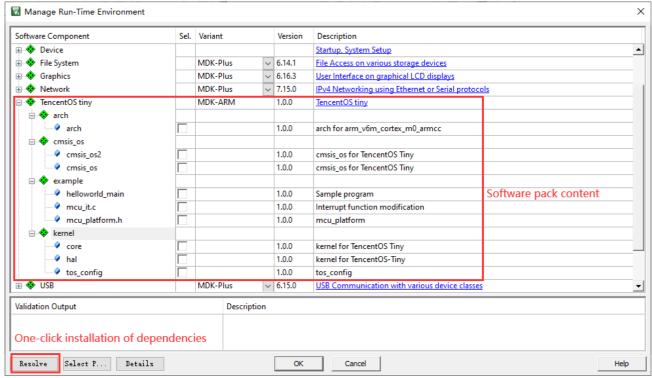


Figure 2.3 Manage Run-Time Environment interface

3. Pack testing

3.1 ARM kernel porting of the TencentOS tiny pack

First download and install the ARM CMSIS-5.7.0 pack from MDK5 Software Packs (keil.com) in order to test this pack under different kernels.

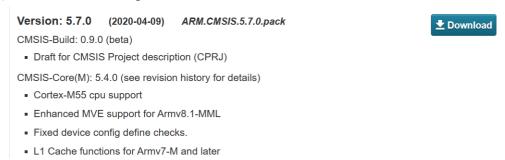


Figure 3.1 ARM CMSIS-5.7.0 pack

After installing the pack, the pack was ported and compiled using the ARM Cortex-M3 kernel as an example. Firstly, a new project was created using the Keil5-5.30 software and ARMCM3 was selected as shown in Figure 3.2, then the corresponding TencentOS-tiny components and Cortex-M3 kernel files were checked according to Figure 3.3, and it can be seen that arch and too config have both been automatically adapted according to the kernel.

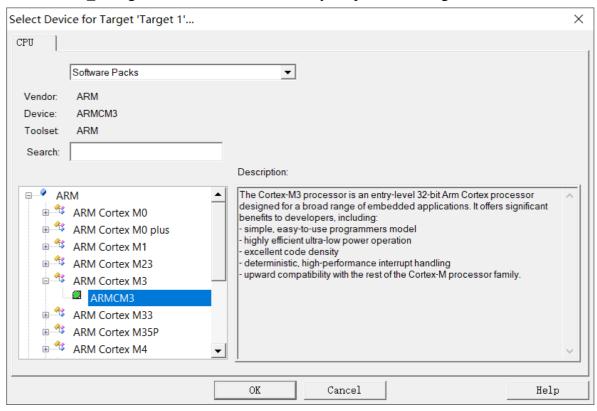


Figure 3.2 Checking the kernel

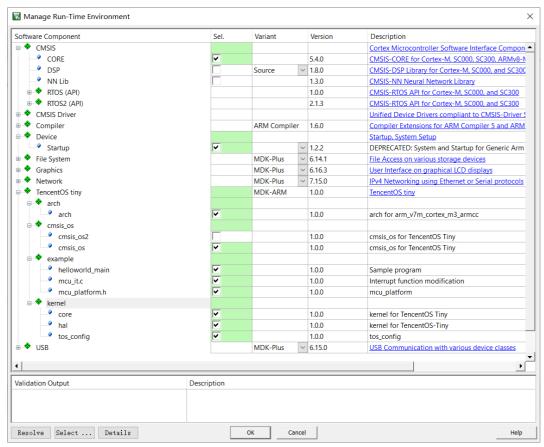


Figure 3.3 Checking components

Next click on Options for target, check Use MicroLIB and the default compile version 5, thenselect C99 mode.

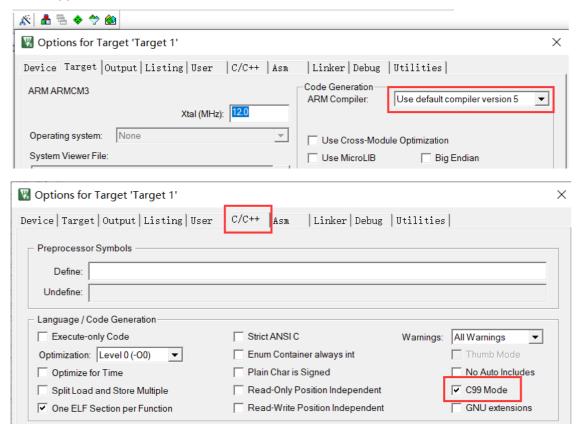


Figure 3.4 Options for target

Then add the #include "ARMCM3.h" and #include "core_cm3.h" header files to mcu platform.h.

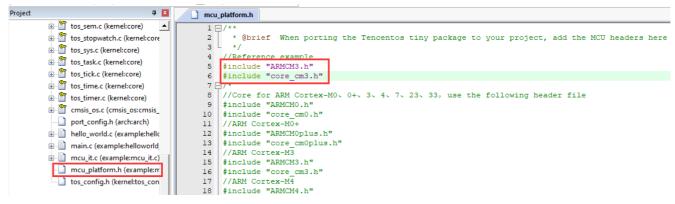


Figure 3.5 Adding the corresponding kernel header file

Finally click on the Build icon to test, as shown in Figure 3.6.

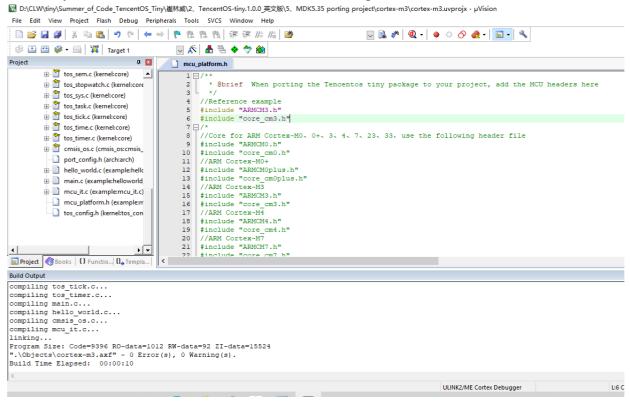


Figure 3.6 Compilation test

Similarly, to test this pack under the ARM Cortex-M4 core, simply modify the header files in mcu_platform. h to #include "ARMCM4.h" and #include "core_cm4.h" in the above steps, or modifythe header files correspondingly for other cores.

3.2 STM32-independent bare-metal engineering port

Next the specific microcontroller chip is selected and the pack is tested, following the following steps.

Download the software support pack for the STM32F1 from the website MDK5 Software Packs (keil.com), as shown in Figure 3.7, and install it.

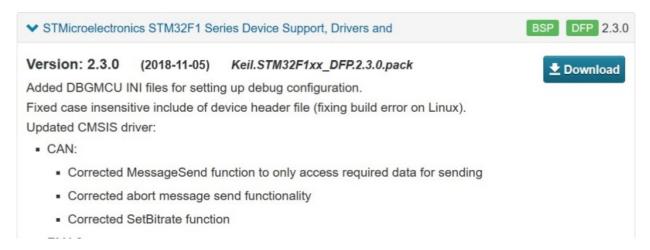


Figure 3.7 STM32 software support pack

Create a new project, select the chip as STM32F103C8 as shown in Figure 3.8, then click ok and select the components of the TencentOS-tiny pack and the STM32 boot file as shown in Figure 3.9.

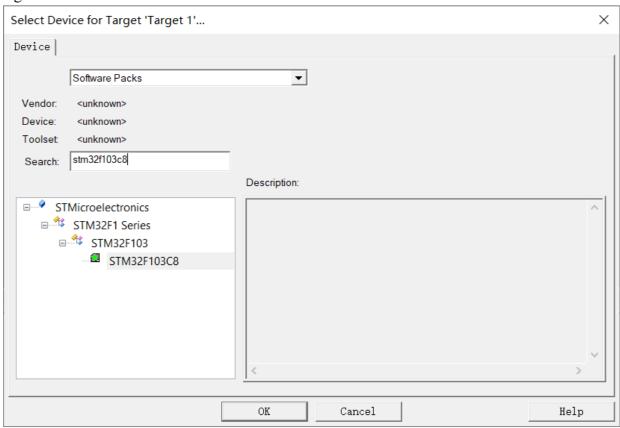


Figure 3.8 Selecting the STM32F103C8 chip

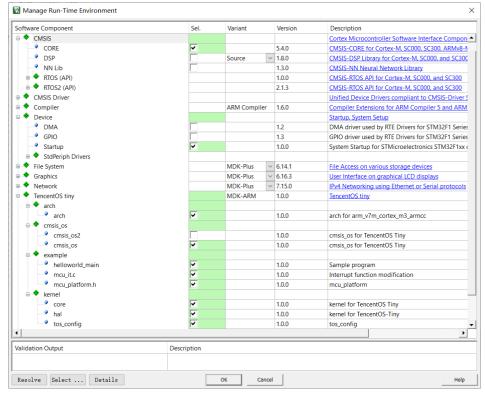
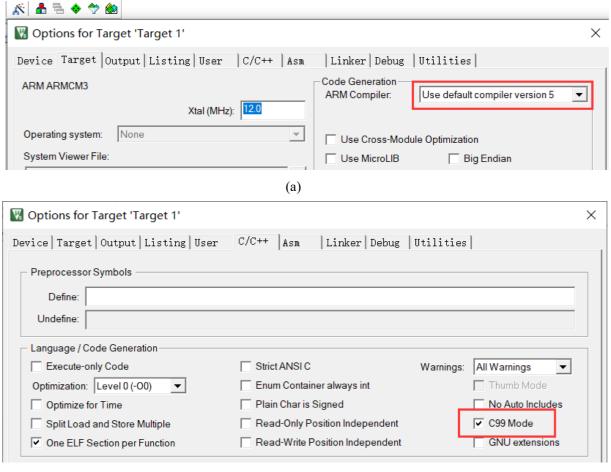


Figure 3.9 Selecting components

Then tick compile version 5 as shown in Figure 3.10(a), and select C99mode.



(b)

Figure 3.10 Software settings

Then add the following header file to mcu platform. h, as shown in Figure 3.11.

#include "stm32f10x.h"
#include "core_cm3.h"
#include "system stm32f10x.h"

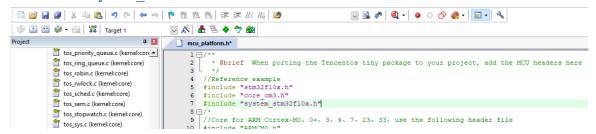


Figure 3.11 Modifying mcu_platform.h

Finally, click Build to compile and if no errors are reported, the port is successful.

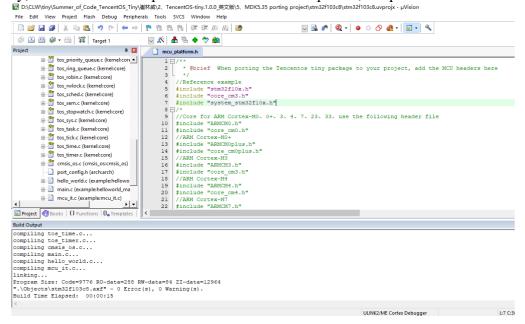


Figure 3.12 Compilation interface

3.3 Microcontroller bare-metal engineering port

Finally, the microcontroller development board is tested and the TencentOS-tiny package is introduced using the Positive Point Atomic Explorer STM32F407ZGT6 as an example.

(1) The following diagram shows the contents of the package ticker. TencentOS tiny □ ◆ arch arch 1.0.0 arch for arm_v7m_cortex_m4_armcc cmsis_os cmsis_os2 cmsis_os for TencentOS Tiny 1.0.0 cmsis_os 1.0.0 cmsis_os for TencentOS Tiny example helloworld_main 1.0.0 Sample program mcu_it.c 1.0.0 Interrupt function modification mcu_platform.h 1.0.0 mcu_platform 1.0.0 kernel for TencentOS Tiny core • hal 100 kernel for TencentOS-Tiny tos_config tos_config

Figure 3.13 Pack components ticked

The interface after porting the pack in the Positive Point Atomic Explorer STM32F407ZGT6 bare-metal project template is shown in Figure 3.14.

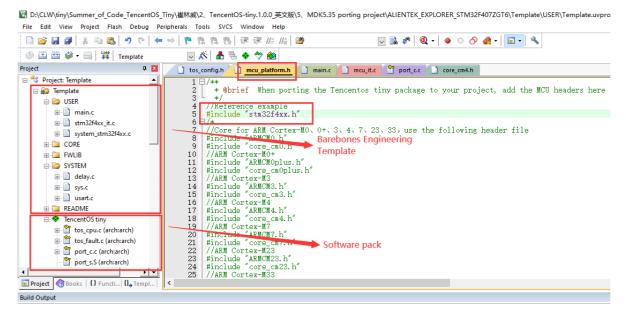


Figure 3.14 Migration interface

(2) Then follow mcu_it.c to modify the PendSV_Handler() function and SysTick_Handler() function in stm32f4xx_it.c as shown below, comment out the PendSV_Handler() function in stm32f4xx it.c, and modify the SysTick Handler() function.

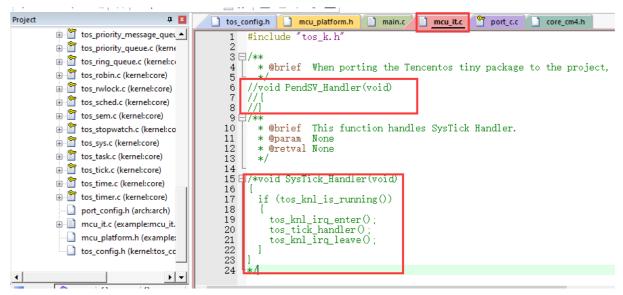


Figure 3.15 Function modification

(3) Modify mcu_platform.h by adding #include "stm32f4xx.h"

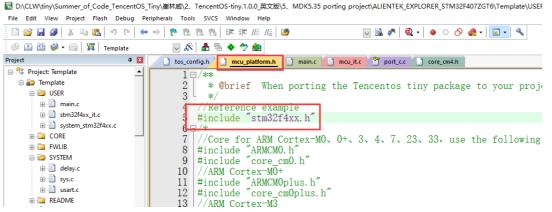


Figure 3.16 Modifying mcu platform.h

(4) Next, use the following main program.

```
#include "stm32f4xx.h"
#include "usart.h"
#include "tos k.h"
k task t task1;
k task t task2;
k stack t task stack1[1024];
k stack t task stack2[1024];
void test task1(void *Parameter)
  while(1)
     printf("task1 running\r\n");
    tos task delay(200);
void test task2(void *Parameter)
  k err t err;
  printf("task2 running\r\n");
  tos task delay(2000);
  // suspend task1
  printf("suspend task1\r\n");
  err = tos task suspend(&task1);
  if(err != K ERR NONE)
     printf("suspend task1 fail! code : %d \r\n",err);
  tos task delay(2000);
  // resume task1
  printf("resume task1\r\n");
  err = tos task resume(&task1);
  if(err != K ERR NONE)
     printf("resume task1 fail! code : %d \r\n",err);
  tos task delay(2000);
  // destroy task1
  printf("destroy task1\r\n");
  err = tos task destroy(&task1);
  if(err != K ERR NONE)
     printf("destroy task1 fail! code : %d \r\n",err);
  // task2 running
  while(1)
     printf("task2 running\r\n");
     tos task delay(1000);
 * @brief main function
 * @param none
 * @retval none
int main(void)
  k err t err;
  /* Initialize USART configuration mode to 115200 8-N-1, interrupt function receive*/
  uart init(115200);
  printf("Welcome to TencentOS tiny\r\n");
  tos knl init(); // TOS Tiny kernel initialize
  tos robin default timeslice config((k timeslice t)500u);
  printf("create task1\r\n");
```

```
err = tos_task_create(&task1, "task1", test_task1, NULL, 3, task_stack1, 1024, 20); if(err != K_ERR_NONE)  
    printf("TencentOS Create task1 fail! code : %d \r\n",err); 
    printf("create task2\r\n"); 
    err = tos_task_create(&task2, "task2", test_task2, NULL, 4, task_stack2, 1024, 20); 
    if(err != K_ERR_NONE)  
        printf("TencentOS Create task2 fail! code : %d \r\n",err); 
    tos_knl_start(); // Start TOS Tiny
```

(5) Then click compile and use ST LINK-V2 to download the program to the microcontroller as shown in Figure 3.17. Then connect the serial port of the microcontroller to the computer and use XCOM serial communication assistant to view the result as shown in Figure 3.18.

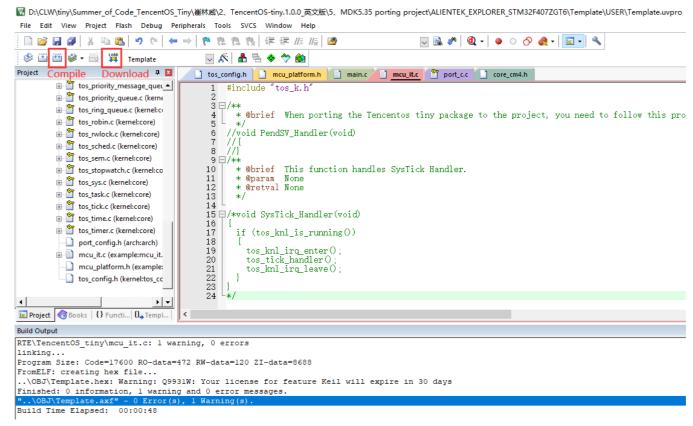


Figure 3.17 Compilation interface



Figure 3.18 Test interface

In addition, if you encounter the error in Figure 3.19(a) during compilation, you need to change #define TOS_CFG_OBJECT_VERIFY_EN 1u to TOS_CFG_OBJECT_VERIFY_EN 0u in Figure 3.19(b)

```
Build Output

compiling tos_priority_queue.c...
compiling tos_ring_queue.c...
compiling tos_ring_queue.c...
compiling tos_robin.c...
compiling tos_robin.c...
compiling tos_sched.c...
files_sched.c...
compiling tos_sched.c...
files_sched.c...
compiling tos_sched.c...
compiling tos_sched.c...
files_sched.c...
```

Figure 3.19 Error reporting modification

4. Summary

In this paper, we firstly studied the development process of completing third-party pack packaging based on MDK and wrote the steps of pack creation, and then combined with TencentOS Tiny IoT operating system to pack the files under ARM kernel architecture in it, so as to design the pack based on TencentOS Tiny.

This pack enables developers to quickly port the TencentOS Tiny operating system to the user's ARM kernel microcontroller, greatly saving development porting time, while the pack features automatic kernel adaptation and dependency hints to improve porting efficiency.

5. Development reference

- 1. Tencent IoT OS website https://github.com/OpenAtomFoundation/TencentOS-tiny
- 2. MDK5 Software Packs MDK5 Software Packs (keil.com)
- 3. Production of software pack training videos https://www.bilibili.com/video/BV1AK411p7d9
- 4. Production pack blog https://blog.csdn.net/qq 40259429/article/details/119320319
- 5. Make a simple pack https://www.cnblogs.com/libra13179/p/6273415.html
- 6. CMSIS-Driver pack <u>ARM-software/CMSIS-Driver: Repository of microcontroller peripheral</u> drivers implementing the CMSIS-Driver API specification (github.com)

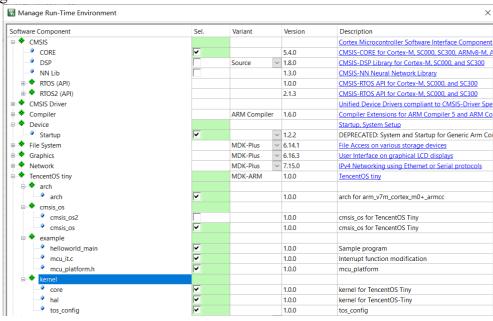
- 6. Appendix Migration Configuration Reference
- 6.1 MDK version 5.14 ported to ARM core
- 6.1.1 Cortex-M0 core porting
- (1) Manage Run-Time Environment is ticked as follows.

Software Component	Sel.	Variant		Version	Description
					Cortex Microcontroller Software Interface Componen
CORE	V			5.4.0	CMSIS-CORE for Cortex-M, SC000, SC300, ARMv8-M,
DSP		Source	~	1.8.0	CMSIS-DSP Library for Cortex-M, SC000, and SC300
→ NN Lib				1.3.0	CMSIS-NN Neural Network Library
⊕ ◆ RTOS (API)				1.0.0	CMSIS-RTOS API for Cortex-M, SC000, and SC300
⊕ ◆ RTOS2 (API)				2.1.3	CMSIS-RTOS API for Cortex-M, SC000, and SC300
CMSIS Driver					Unified Device Drivers compliant to CMSIS-Driver Sp
Compiler		ARM Compiler		1.6.0	Compiler Extensions for ARM Compiler 5 and ARM C
Device					Startup, System Setup
Startup	~		~	1.2.2	DEPRECATED: System and Startup for Generic Arm C
File System		MDK-Plus	~	6.14.1	File Access on various storage devices
⊕ ❖ Graphics		MDK-Plus	~	6.16.3	User Interface on graphical LCD displays
Network		MDK-Plus	~	7.15.0	IPv4 Networking using Ethernet or Serial protocols
		MDK-ARM		1.0.0	TencentOS tiny
□ ◆ arch					
arch	V			1.0.0	arch for arm_v6m_cortex_m0_armcc
⊕ ❖ cmsis_os					
cmsis_os2				1.0.0	cmsis_os for TencentOS Tiny
cmsis_os	▽			1.0.0	cmsis_os for TencentOS Tiny
□ ◆ example					
helloworld_main	<u>~</u>			1.0.0	Sample program
mcu_it.c	V			1.0.0	Interrupt function modification
mcu_platform.h	V			1.0.0	mcu_platform
e 💠 kernel					
core	V			1.0.0	kernel for TencentOS Tiny
hal	~			1.0.0	kernel for TencentOS-Tiny
* tos_config	V			1.0.0	tos_config

(2) In mcu platform.h, add:

#include "ARMCM0.h" #include "core cm0.h"

- 6.1.2 Cortex-M0+ core porting
 - (1) Manage Run-Time Environment is ticked as follows.



(2) In mcu_platform.h, add.

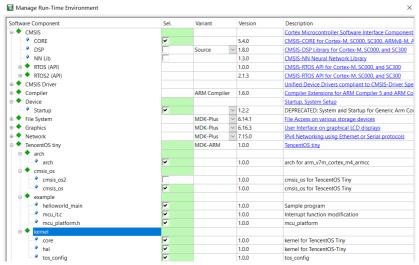
#include "ARMCM0plus.h" #include "core_cm0plus.h"

- 6.1.3 Cortex-M3 core porting
 - (1) Manage Run-Time Environment is ticked as follows.

(2) In mcu_platform.h, add.

#include "ARMCM3.h" #include "core cm3.h"

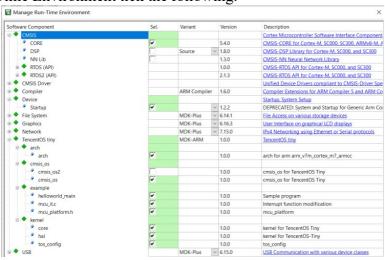
- 6.1.4 Cortex-M4 core porting
 - (1) Manage Run-Time Environment is ticked as follows.



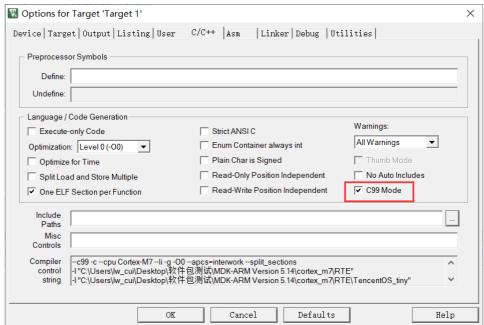
(2) In mcu platform.h, add.

#include "ARMCM4.h" #include "core_cm4.h"

- 6.1.5 Cortex-M7 core porting
 - (1) Manage Run-Time Environment tick the following.



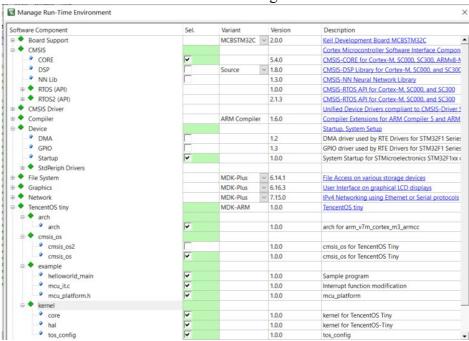
(2) Modified to C99 in MDK



(3) In mcu_platform.h, add.

#include "ARMCM7.h" #include "core cm7.h"

- 6.2 MDK version 5.14 ported to ARM core-based chips
- 6.2.1 Porting to the STM32F103C8 chip
 - (1) Manage Run-Time Environment tick the following.



(2) In mcu_platform.h, add.

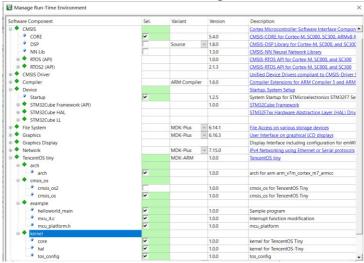
#include "stm32f10x.h"

#include "core_cm3.h"

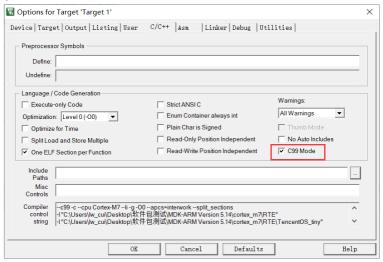
#include "system stm32f10x.h"

6.2.2 Porting to the STM32F767IGTx chip

(1) Manage Run-Time Environment tick the following.



(2) Modified to C99 in MDK



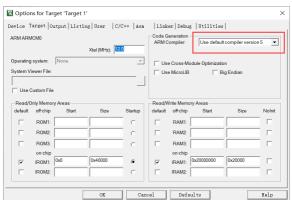
(3) In mcu platform.h, add.

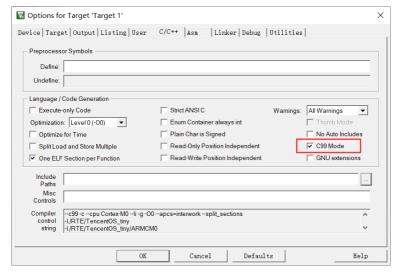
#include "stm32f7xx.h" #include "core cm7.h"

#include "system_stm32f7xx.h"

6.3 MDK5.30 and MDK5.35 porting (Cortex-M0+, 0, 3, 4, 7 cores and chips)

When porting TencentOS-tiny Pack to Keil in MDK5.30 and MDK5.35, for Cortex-M0+, 0, 3, 4 and 7 kernels and chips, the steps for ticking components and adding header files are the same as before, but you need to modify the compiler version as follows and then just execute the compilation.

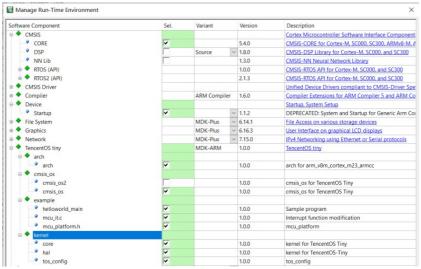




6.4 MDK5.30 and MDK5.35 porting (Cortex-M23, 33)

6.4.1 Cortex-M23 core porting

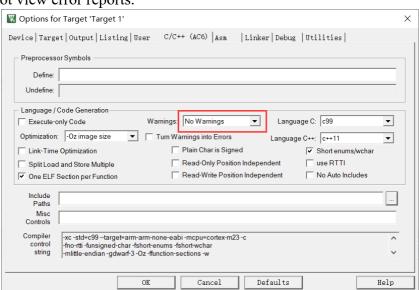
(1) Manage Run-Time Environment is ticked as follows.



(2) In mcu platform.h, add.

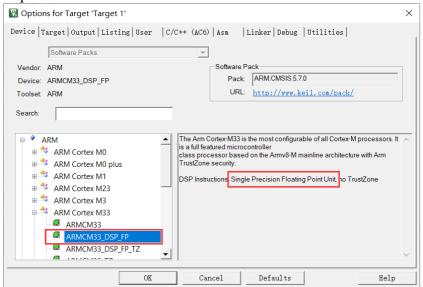
#include "ARMCM23.h" #include "core cm23.h"

(3) Amend to not view error reports.

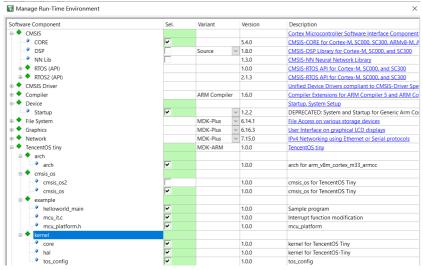


6.4.2 Cortex-M33 core port

(1) Selecting a chip with FPU



(2) Manage Run-Time Environment is ticked as follows.



(3) In mcu_platform.h, add.

#include "ARMCM33_DSP_FP.h" #include "core cm33.h"

(4) Amend to not view error reports.

